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OFFICIAL

FACSIMILE COMMUNICATION

To: IMAGING

Date: 10/30/03

Fax #: 703 872-9306

Re: Application No. 09/926,791
Inventor: Thomas GRASSL

From: Justin J. Cassell

Total pages: Five

Confidential/Privileged

This communication contains confidential information that is intended to be received and read only by the party named as addressee listed after "To:" at the left. This communication may contain information that is subject to the attorney/client privilege and/or a court order restricting its dissemination. No one else is entitled to read, use, copy or disseminate this communication or the information contained herein. If you are not the addressee, or the agent of the addressee, then contact us immediately by telephone (collect) or facsimile and arrangements will be made for the return to us of this communication.

Thank you, BACON & THOMAS, PLLC.

Message: Examiner Michael T. TRAN, Art Unit: 2818 (Telephone 703 308-4838) requested that the attached Supplemental Amendment be sent to him via facsimile.

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

PATENT

IN RE APPLICATION OF: THOMAS GRASSL

SERIAL NO.: 09/926,791

FILED: December 20, 2001

FOR: SEMICONDUCTOR MEMORY CHIP MODULE

OFFICIAL - VIA FACSIMILE

GROUP ART UNIT: 2818

EXAMINER: Michael T. TRAN

ATTY. REFERENCE: GRAS3005/JEK/JJC

CONFIRMATION NO.: 8662

I HEREBY CERTIFY THAT THIS
PAPER IS BEING FACSIMILE
TRANSMITTED TO THE U.S. P.T.O.
ON THE DATE SHOWN BELOW.

(PRINT) JANET F. YMOUSE
(SIGN) Janet F. Ymoose
(DATE) October 30, 2003

COMMISSIONER OF PATENTS

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

Transmitted herewith is a **SUPPLEMENTAL AMENDMENT** in the above-identified application.
☐ Small entity status under 37 CFR 1.9 and 1.27 is claimed.

☒ No additional fee is required.

The fee, if any, has been calculated as shown below:

Fee Basis	Number of Claims After Amendment	Highest Number Previously Paid For	Extra Claims	Small Entity	Full Fee
Total Claims	-	1	=	× \$ 9 =	× \$ 18 =
Independent Claims	-	3	=	× \$ 43 =	× \$ 86 =
<input type="checkbox"/> First Presentation of Proper Multiple Dependent Claim				+ \$145 =	+ \$290 =
TOTAL					

¹ If less than 20 enter 20.² If less than 3 enter 3.³ If less than 0 enter 0.

- ☐ Please charge my Deposit Account Number 02-0200 in the amount of \$_____. A duplicate copy of this sheet is attached.
- ☐ A check in the amount of \$_____ is attached.
- ☒ The Commissioner is hereby authorized to charge any additional fees associated with this communication, including fees due under 37 CFR 1.16 and 37 CFR 1.17 or credit any overpayment to Deposit Account Number 02-0200. A duplicate copy of this sheet is attached.
- ☐ Also enclosed is/are:

23364

Customer Number

Phone: (703) 683-0500

DATE: October 30, 2003

Respectfully submitted,

Justin J. Cassell
JUSTIN J. CASSELL
Attorney for Applicant
Registration Number: 46,205

OCT 30 2003

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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Inventor: Thomas GRASSL

Application No.: 09/926,791

Confirmation No: 8662

Filed: December 20, 2001

Attorney No.: GRAS3005/JEK/JJC

Customer No.: 23364

Examiner: Michael T. TRAN

Art Unit: 2818

For: SEMICONDUCTOR MEMORY CHIP MODULE

SUPPLEMENTAL AMENDMENTCommissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

INTRODUCTORY COMMENTS

This amendment is supplemental to the amendment filed on July 23, 2003 and is responsive to the telephonic interview between the Examiner and Applicant's representative on October 29, 2003. Entry of the following amendment is respectfully requested.

An amendment of the written description is presented below under the heading "Amendment of the Specification."